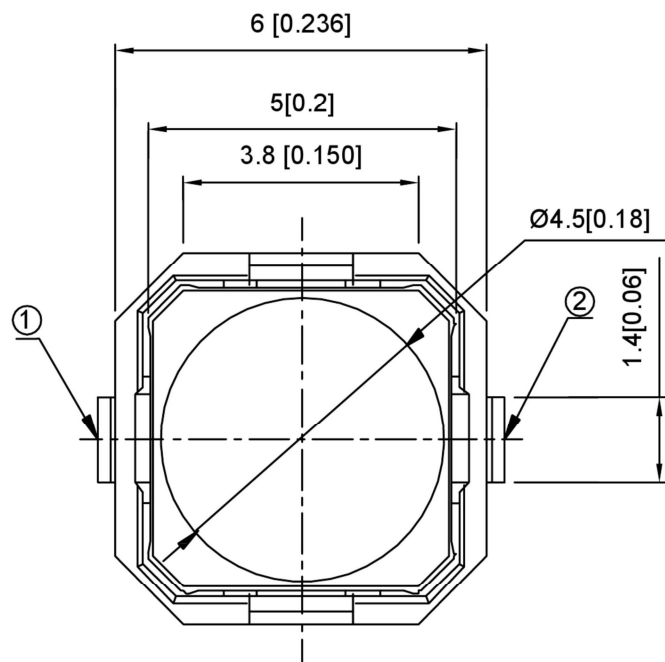
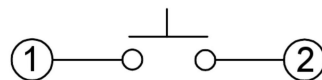
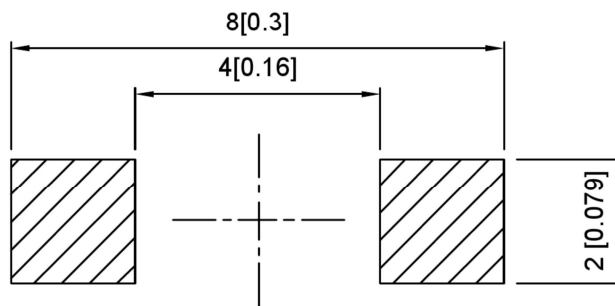




CIRCUIT DIAGRAM



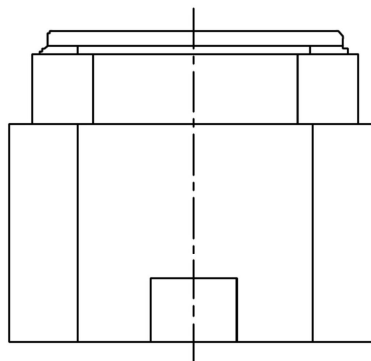
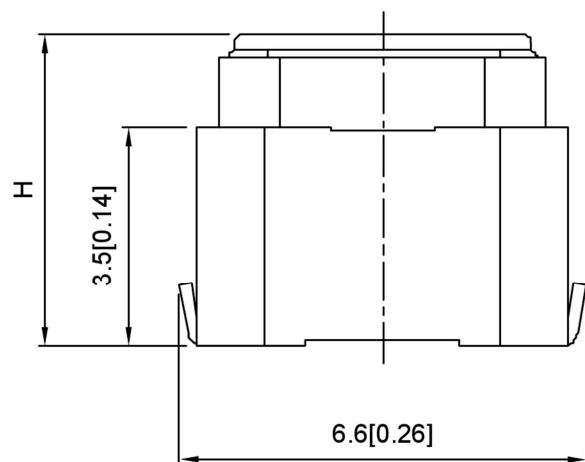
SMD REFLOW PATTERN



SPECIFICATION

Contact Rating:	50mA, 12V DC
Contact Resistance:	100mΩ max
Insulation Resistance:	100mΩ min. 500V DC
Dielectric Strength:	250V AC/1minute
Travel:	1.3mm
Operating Temp:	-30°C ~ +85°C
Storage Temp:	-30°C ~ +80°C

PAPT NO	TS-1199A-X-X
Operating Force	A:160gf B:200gf C:260gf
Height	H:A:4.3 B:5.0



⑤	Terminal	—	2	Brass (0.30t)	Plating silvering	—
④	Contact	—	1	F.ag/Sus	Natural	—
③	Base	—	1	Lcp		—
②	Cover	—	1	Lcp		—
①	Keystake	—	1	Lcp		—
ITEM	PAPT NAMF	TER,NO	QTY	MATERIAL	FINISHING	REMARK

				ANGLAR	±5°
				L ≤ 4	±0.2
				4 < L ≤ 16	±0.3
				16 < L ≤ 63	±0.4
	DATE	REVISED	APPROVED	L > 63	±0.5
				UNSPECIFIED TOLERANCES	
www.alpsr.com www.gdxjdz.com www.xbswitch.com					



DSND		SCALE: N/A	MODEL TYPE:
DWN		VIEW:	TACT SWITCH
CHKD		UNIT: mm/in	PART NO.:
APPD		SIZE: A4	TS-1199A-X-X
			DWG NO.:
			WEIGHT
			SHEET
			REVISIC
			1/1
			A0

DONG GUAN XI BANG ELECTRONIC CO., LTD